

1200 V

530 A

CAB530M12BM3, CAB530M12BM3T

1200 V, 530 A All-Silicon Carbide, Half-Bridge Module

Technical Features

- Industry Standard 62 mm Footprint
- Ultra Low Loss, High-Frequency Operation
- Zero Turn-off Tail Current from MOSFET
- Normally-off, Fail-safe Device Operation
- Copper Baseplate and Aluminum Nitride Insulator



V_{DS}

I_{DS}

Applications

- Railway & Traction
- EV Charging Infrastructure
- Industrial Automation & Testing
- High-Frequency Power Supplies
- Renewable Energy Systems & Grid-Tied Inverters
- Active Front Ends & AC InvertersUPS and SMPS

System Benefits

- Lightweight, Compact Form-Factor with 62 mm-Format Enables System Retrofit
- Increased System Efficiency due to Low Switching & Conduction Losses of SiC

Key Parameters

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
Drain-Source Voltage	V _{DS}			1200		T _c = 25 °C	
Gate-Source Voltage, Maximum Value	V _{GS(max)}	-10		+23	V	Transient	Note 1
Gate-Source Voltage, Recommended	V _{GS(op)}		-4/+15			Static	Fig. 32
DC Continuous Drain Current	I _D		719		-	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25 \text{ °C}, \text{ T}_{VJ} \le 175 \text{ °C}$	Notes
			541			$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 90 \text{ °C}, \text{ T}_{VJ} \le 175 \text{ °C}$	
DC Source-Drain Current (Body Diode)	I _{SD(BD)}		442		A	$V_{GS} = -4 V, T_{C} = 25 \text{ °C}, T_{VJ} \le 175 \text{ °C}$	2, 3 Fig. 21
Pulsed Drain-Source Current	I _{DM}		1060			t_{Pmax} limited by T_{VJmax} V _{GS} = 15 V, T _C = 25 °C	1
Power Dissipation	P _D		2308		w	$T_{c} = 25 \text{ °C}, T_{v_{J}} \le 175 \text{ °C}$	Note 4 Fig. 21
Virtual Junction Temperature		10		150	°C	Operation	
	T _{VJ(op)}	-40		175		Intermittent with Reduced Life	

Note (1): Recommended turn-on gate voltage is 15 V with ±5 % regulation tolerance. Not for use in linear region.

Note (2): Current limit at $T_c = 90 \degree C$ calculated by $I_{D(max)} = \sqrt{(P_D/R_{DS(typ)}(T_{VJ(max)}, I_{D(max)}))}$

Note (3): Verified by design

Note (4): $P_D = (T_{VJ} - T_C)/R_{TH(JC,typ)}$

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1200			v	V _{GS} = 0 V, T _{VJ} = -40 °C	
Gate Threshold Voltage	V _{GS(th)}	1.8	2.5	3.6		$V_{DS} = V_{GS}, I_{D} = 140 \text{ mA}$	
Zero Gate Voltage Drain Current	I _{DSS}		10	250		$V_{GS} = 0 V, V_{DS} = 1200 V$	
Gate-Source Leakage Current	I _{GSS}			2	μΑ	$V_{GS} = 15 \text{ V}, V_{DS} = 0 \text{ V}$	
Drain-Source On-State Resistance (Devices			2.67	3.55	mΩ	$V_{GS} = 15 \text{ V}, I_{D} = 530 \text{ A}$	Fig. 2 Fig. 3
Only)	R _{DS(on)}		3.96			$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 530 \text{ A}, \text{ T}_{VJ} = 150 \text{ °C}$	
			375		S	$V_{DS} = 20 \text{ V}, I_{DS} = 530 \text{ A}$	- Fig. 4
Transconductance	g _{fs}		364			$V_{\rm DS} = 20$ V, $I_{\rm DS} = 530$ A, $T_{\rm VJ} = 150$ °C	
Turn-On Switching Energy, TJ = 25 °C TJ = 125 °C TJ = 150 °C	E _{on}		16.8 15.6 16.1			$V_{DS} = 600 \text{ V}, I_D = 530 \text{ A}, \\ V_{GS} = -4 \text{ V}/+15 \text{ V}, \\ R_{G(ext)} = 1.5 \Omega, L = 13.6 \mu\text{H}$	Fig. 11 Fig. 13
Turn-Off Switching Energy, $T_J = 25 \degree C$ $T_J = 125 \degree C$ $T_J = 150 \degree C$	E _{OFF}		15.5 14.9 14.9		mJ		
Internal Gate Resistance	R _{G(int)}		2.9		Ω	V _{AC} = 25 mV, f = 100 kHz	
Input Capacitance	C _{iss}		39.6		_		
Output Capacitance	C _{oss}		1.4		nF	V _{GS} = 0 V, V _{DS} = 800 V, V _{AC} = 25 mV, f = 100 kHz	Fig. 9
Reverse Transfer Capacitance	C _{rss}		84		pF		
Gate to Source Charge	Q _{GS}		384			$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/+15 \text{ V}$ $I_D = 530 \text{ A}$ Per IEC60747-8-4 pg 21	
Gate to Drain Charge	Q _{GD}		462		nC		
Total Gate Charge	Q _G		1362				
FET Thermal Resistance, Junction to Case	R _{th JC}		0.065		°C/W		Fig. 17

MOSFET Characteristics (Per Position) (T_{vJ} = 25 °C Unless Otherwise Specified)

Diode Characteristics (Per Position) (T_{vJ} = 25 °C Unless Otherwise Specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	Note
Diode Forward Voltage			5.7		V	$V_{GS} = -4 \text{ V}, I_F = 530 \text{ A}, T_{VJ} = 25 \text{ °C}$	Fig. 7
	V _F		5.0			$V_{GS} = -4 \text{ V}, \text{ I}_{F} = 530 \text{ A}, \text{ T}_{VJ} = 150 \text{ °C}$	
Reverse Recovery Time	t _{rr}		44		ns	V _{GS} = -5 V, I _{SD} = 530 A, V _R = 800 V di _F /dt = 14.0 A/ns, T _{VJ} = 150 °C	Fig. 31
Reverse Recovery Charge	Q _{RR}		8.5		μC		
Peak Reverse Recovery Current	I _{RRM}		300		A		
Diode Energy T _{vJ} = 25 °C T _{vJ} = 125 °C T _{vJ} = 150 °C	Err		0.52 1.75 2.37		mJ	$\label{eq:V_DS} \begin{array}{l} V_{\text{DS}} = 600 \; V, \; I_{\text{D}} = 530 \; \text{A}, \\ V_{\text{GS}} = -5 \; V/20 \; V, \; R_{\text{G}(\text{ext})} = 1.5 \; \Omega, \\ L = 13.6 \; \mu\text{H} \end{array}$	Fig. 14

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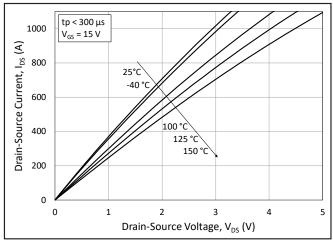
Module Physical Characteristics

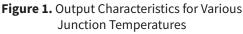
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
	P		0.42			T _c = 25 °C, I _{sp} = 530 A, Note 5
Package Resistance, M1 (High-Side)	R ₁₋₃		0.60			T _c = 150 °C, I _{sp} = 530 A, Note 5
Deckage Decisteres M2 (Low Cide)	P		0.28		mΩ	T _c = 25 °C, I _{sp} = 530 A, Note 5
Package Resistance, M2 (Low-Side)	R ₁₋₂		0.40			T _c = 150 °C, I _{sp} = 530 A, Note 5
Stray Inductance	L _{Stray}		11.1		nH	Between Terminals 1 and 3
Case Temperature	Tc	-40		125	°C	
Weight	W		300		g	
Mounting Torque		4	5	5.5	N-m	Baseplate, M6-1.0 Bolts
	Ms	4	5	5.5		Power Terminals, M6-1.0 Bolts
Case Isolation Voltage	V _{isol}	5			kV	AC, 50 Hz, 1 min
Clearance Distance		9				Terminal to Terminal
		30				Terminal to Baseplate
Creepage Distance		30			mm	Terminal to Terminal
		40				Terminal to Baseplate

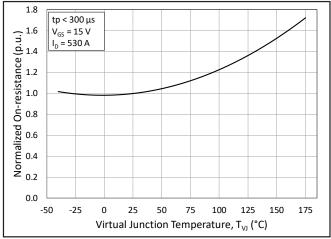
Note (5): Total Effective Resistance (Per Switch Position) = MOSFET R_{DS(on)} + Switch Position Package Resistance

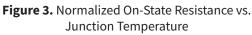
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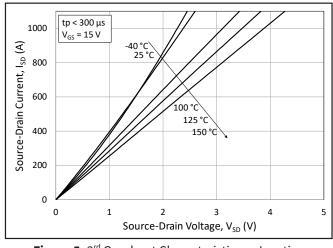


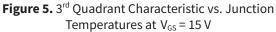












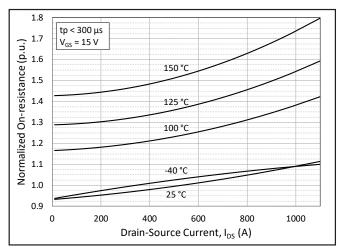


Figure 2. Normalized On-State Resistance vs. Drain Current for Various Junction Temperatures

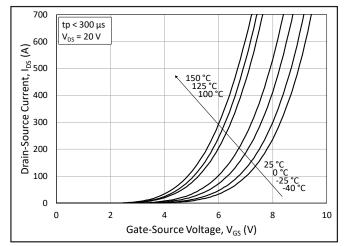
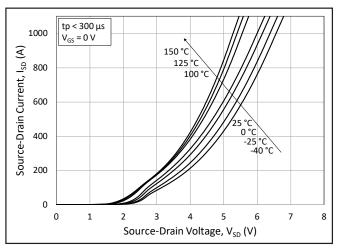


Figure 4. Transfer Characteristic for Various Junction Temperatures





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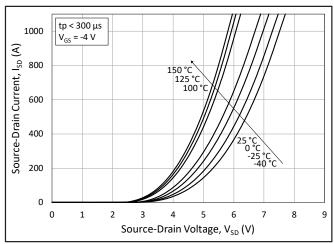
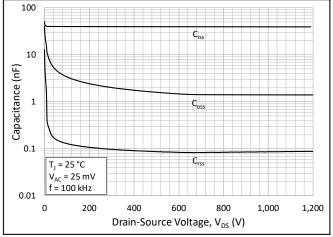
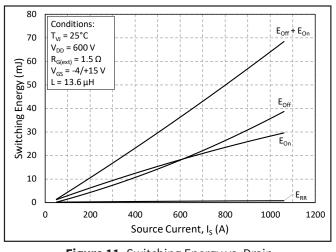
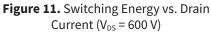


Figure 7. 3^{rd} Quadrant Characteristic vs. Junction Temperatures at V_{GS} = -4 V (Diode)









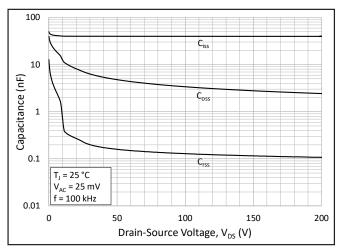


Figure 8. Typical Capacitances vs. Drain to Source Voltage (0 V - 200 V)

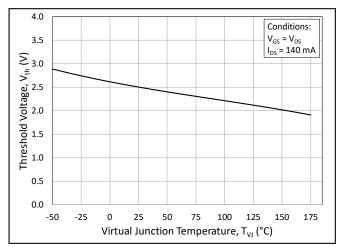
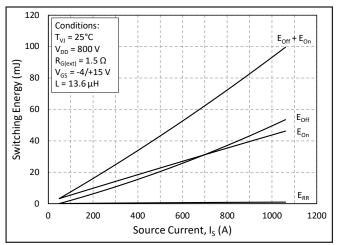
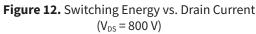


Figure 10. Threshold Voltage vs. Junction Temperature

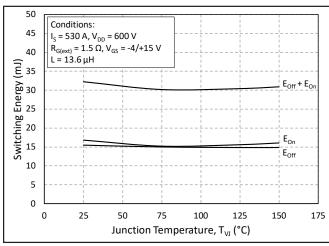




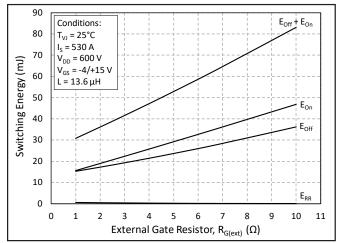
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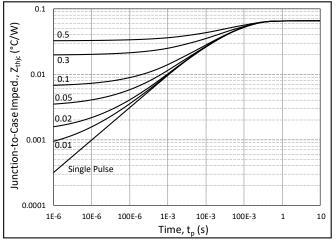


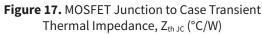












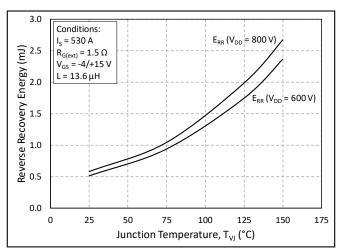


Figure 14. Reverse Recovery Energy vs. Junction Temperature

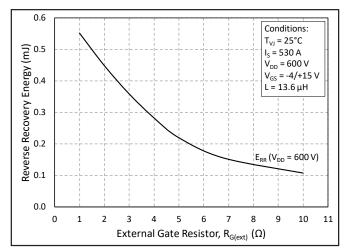


Figure 16. Reverse Recovery Energy vs. External Gate Resistance

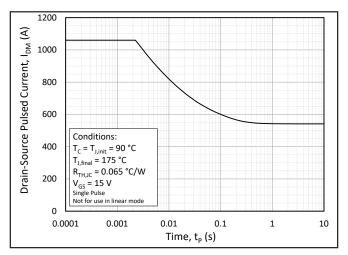


Figure 18. Pulsed Current Safe Operating Area

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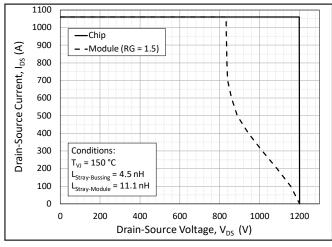


Figure 19. Reverse Bias Safe Operating Area (RBSOA)

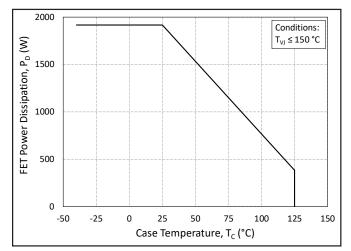


Figure 21. Maximum Power Dissipation Derating vs. Case Temperature

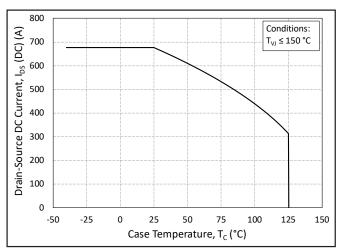


Figure 20. Continuous Drain Current Derating vs. Case Temperature

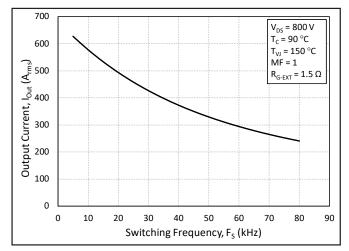


Figure 22. Typical Output Current Capability vs. Switching Frequency (Inverter Application)

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Timing Characteristics

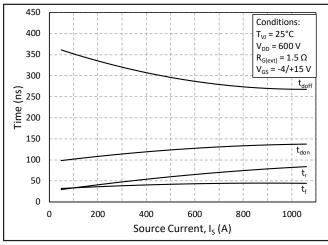
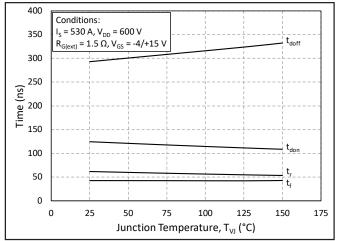
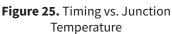
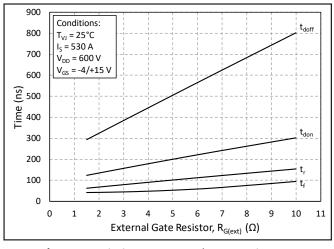


Figure 23. Timing vs. Source Current









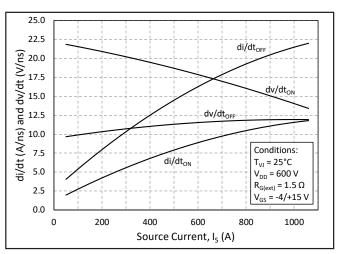


Figure 24. dv/dt and di/dt vs. Source Current

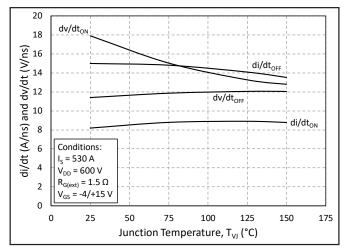


Figure 26. dv/dt and di/dt vs. Junction Temperature

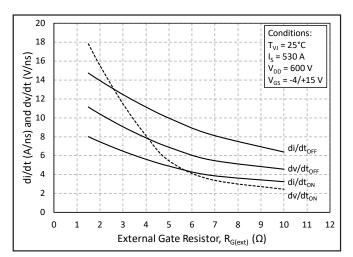


Figure 28. dv/dt and di/dt vs. External Gate Resistance

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Definitions

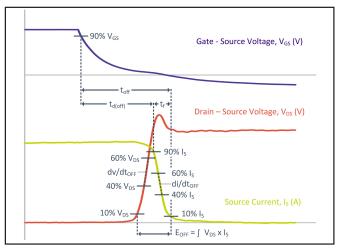


Figure 29. Turn-Off Transient Definitions

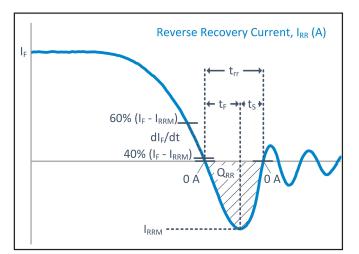


Figure 31. Reverse Recovery Definitions

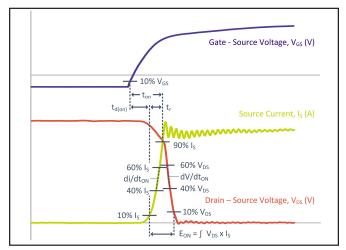


Figure 30. Turn-On Transient Definitions

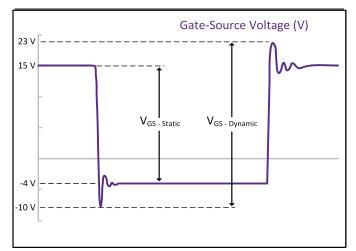
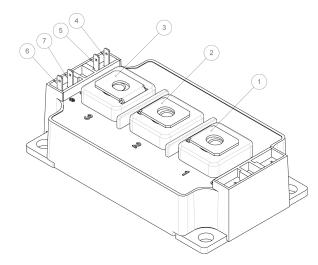


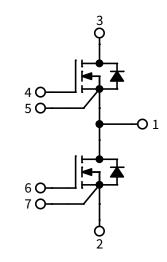
Figure 32. V_{GS} Transient Definitions

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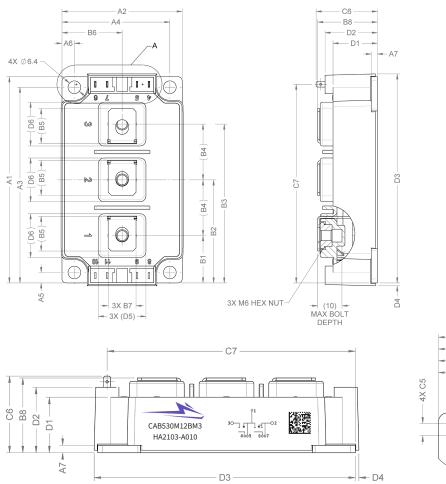
Schematic and Pin Out



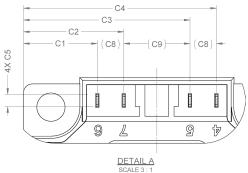


Note 2: The anti-parallel diodes shown in the schematic are MOSFET body diodes.

Package Dimensions (mm)



DIMENSION TABLE						
SYMBOL	DIMENSION	TOLERANCE				
A1	103.5	±0.30				
A2	60.44	±0.30				
A3	98.25	±0.30				
A4	54.22	±0.30				
A5	5.25	±0.30				
A6	6.22	±0.30				
A7	3	±0.30				
B1	23.75	±0.40				
B2	51.75	±0.40				
B3	79.75	±0.40				
B4	(28)	REF.				
B5	(17.43)	REF.				
B6	30.23	±0.40				
B7	(14)	REF.				
B8	30.03	±0.40				
C1	16.73	±0.40				
C2	22.73	±0.40				
C3	37.73	±0.40				
C4	43.73	±0.40				
C5	2.8	±0.40				
C6	30.8	±0.50				
C7	99.75	±0.40				
C8	(6)	REF.				
C9	(15)	REF.				
D1	22.3	±0.30				
D2	26.3	±0.30				
D3	104.95	±0.30				
D4	1.45	±0.40				
D5	(24)	REF.				
D6	(22)	REF.				



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Product Ordering Code

Part Number	Description			
CAB530M12BM3	Without Pre-Applied Phase Change Thermal Interface Material			
CAB530M12BM3T	With Pre-Applied Phase Change Thermal Interface Material			

Supporting Links & Tools

Simulation Tools & Support

- All LTSpice Models
- All PLECS Models
- <u>SpeedFit 2.0 Design Simulator™</u>
- <u>Technical Support Forum</u>

Compatible Evaluation Hardware

- CGD1200HB2P-BM3: Dual Channel Differential Isolated Half Bridge Gate Driver Board
- KIT-CRD-CIL12N-BM: Dynamic Performance Evaluation Board for the BM2 and BM3 Module
- <u>CGD1700HB2P-BM3: Evaluation Gate Driver Tool Optimized for the 1700 V BM3 Power Modules</u>
- <u>KIT-CRD-CIL17N-BM: Dynamic Characterization Evaluation Tool Optimized for 1700 V BM Power Modules</u>
- CGD12HB00D: Differential Transceiver Daughter Board Companion Tool for Differential Gate Drivers

Application Notes

- PRD-07933: Wolfspeed Power Module Thermal Interface Material Application User Guide
- PRD-06379: Environmental Considerations for Power Electronics
- PRD-08710: Measuring Stray Inductance in Power Electronic Systems
- PRD-07845: Power Module Baseplate Capacitance and Electromagnetic Compatibility
- PRD-08376: Thermal Characterization Methods and Applications
- PRD-06933: Capacitance Ratio and Parasitic Turn-On



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